



## PATENT APPLICATION Express Mail Label No. *EL960827955US*Attorney Docket No. SUN-P9610-SPL

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

## <u>UTILITY PATENT</u> <u>APPLICATION TRANSMITTAL LETTER</u>

Asst. Commissioner for Patents Box Patent Application Washington, D.C. 20231

Sir:

Enclosed for filing is an [X] original patent application or, [] a continuation-in-part patent application, by inventor(s) <u>Ivan E. Sutherland, Robert J. Drost, Gary R. Lauterbach, Howard L. Davidson</u>, entitled <u>INTEGRATED CIRCUIT ASSEMBLY MODULE THAT SUPPORTS</u>
CAPACITIVE COMMUNICATION BETWEEN SEMICONDUCTOR DIES.

No. of pages in Application: 22; No. of Claims: 36.

	No. of	Sheets of Drawings: Formal: 2, Informal: 0.							
Also e	nclosed a	ле:							
	[]	a claim for foreign priority under 35 U.S.C. §§ 119 and/or 365 in							
		[] a separate document [] the declaration;							
	[]	a certified copy of the priority document;							
	[]	an Associate Power of Attorney;							
	[]	verified statement(s) claiming small entity status;							
	[x]	a Combined Declaration and Power of Attorney of the inventors(s);							
	[]	a signed Combined Declaration and Power of Attorney of the inventors will follow;							
	[x]	an Assignment document and form PTO-1595;							
	[x]	Request And Certification Under 35 U.S.C. 122(B)(2)(B)(I); and							
	[x]	Information Disclosure Statement and Form PTO-1449 with one reference.							

The fee has been calculated as follows:

CLAIMS								
	NO. OF CLAIMS		EXTRA CLAIMS	RATE	FEE			
Basic Applicati	Basic Application Fee							
Total Claims	36	MINUS 20 =	16	\$18.00=	\$288.00			
Independent Claims	3	MINUS 3 =	0	\$84.00=	\$0.00			
If multiple depe	0							
Total Application Fee					\$1,038.00			
If verified statement claiming small entity status is enclosed, subtract 50% of Total Application Fee								
Add Recording	\$40.00							
TOTAL APPL	\$1,078.00							

- [X] A check in the amount of \$1,078.00 is enclosed.
- [] Application fee will follow with missing parts.
- [X] Please deduct any <u>underpayments</u>, credit any <u>overpayments</u>, and charge all required <u>extension of time fees</u> to Deposit Account Number 50-1003.

Please direct all correspondence concerning the above-identified application to the following address:

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22835

PATENT TRADEMARK OFFICE

Respectfully submitted,

Ву

A. Richard Park

Registration No. 41,241

Date: September 26, 2003

Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it displays a valid OMB control number.

REQUEST AND CERTIFICATION	First Nam d Inventor		Ivan E. Sutherland et al.
UNDER 35 U.S.C. 122(b)(2)(B)(i)	Title	INTEGRATED CIRCUIT ASSEMBLY MODULE THAT SUPPORTS CAPACITIVE COMMUNICATION BETWEEN SEMICONDUCTOR DIES	
	Attorney Docket Number		SUN-P9610-SPL

I hereby certify that the invention disclosed in the attached application has not and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing. I hereby request that the attached application not be published under 35 U.S.C. 122(b).

September 26, 2003 Date

Signature

A. Richard Park (Reg. No 41,241)

Typed or printed name

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application **upon filing**.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under 35 U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing, the applicant must notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application. Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).